



# Product Change Notification

## 113322 - 00

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# Product Change Notification

**Change Notification #:** 113322 - 00  
**Change Title:** Intel® Server System R1304GZ4GC  
PCN 113322-00, Product Design  
Add a Mylar and a Plastic Block  
**Date of Publication:** October 17, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

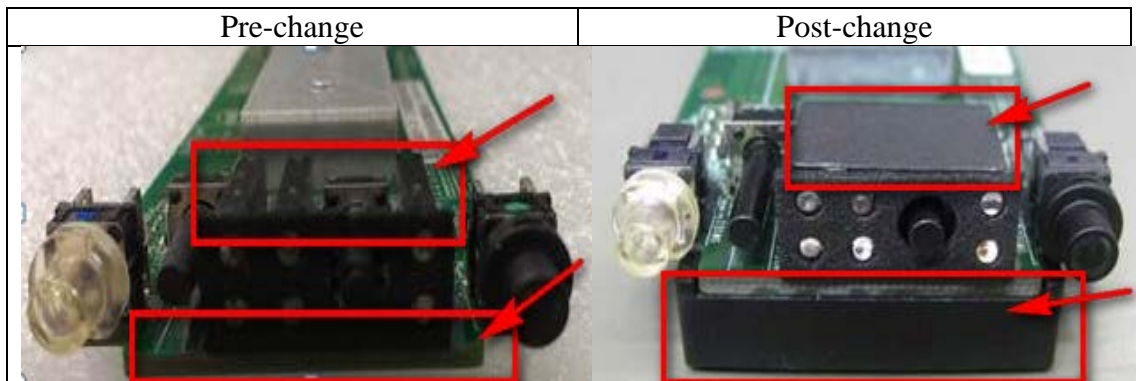
<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	November 1, 2014
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R1304GZ4GC:

Add a mylar on the top of the front panel board and add a plastic block for the front end under the front panel board to hold parts more securely. See the images below:



## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change. Customers may need to validate the function and feature changes once the post-change system is available.

### **Products Affected / Intel Ordering Codes:**

<b>ASMO SKU</b>			
<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Post Change TA</b>
R1304GZ4GC	916994	G50534-008	G50534-009

### **PCN Revision History:**

**Date of Revision:**

October 17, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN